

OFFICIAL

19 PAGES TOTAL

BY TELEFAX TO:  
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DOCKET NO.: 4029

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

IN THE MATTER OF THE APPLICATION FOR PATENT

OF: Michio OSADA et al.

| Art Unit: 1722

SERIAL NO.: 09/705,237

| Confirmation No.: 4586

FILED: November 2, 2000

| EX.: Thukhanh T. Nguyen

FOR: Die Used for Resin-Sealing and  
Molding an Electronic ComponentASSISTANT COMMISSIONER FOR PATENTS  
BOX RESPONSE - NO FEE  
WASHINGTON, D.C. 20231

January 31, 2003

TRANSMITTED HERewith IS A RESPONSE TO THE OFFICE ACTION OF OCTOBER 31, 2002 IN THE ABOVE IDENTIFIED PATENT APPLICATION COMPRISING 14 PAGES. A MARKED-UP VERSION OF AMENDED SPECIFICATION PAGES 4, 6 AND 7 IS ENCLOSED. A MARKED-UP VERSION OF AMENDED CLAIMS 1, 5 AND 7 IS ENCLOSED.

NO ADDITIONAL CLAIM FEE IS REQUIRED, AS SHOWN BELOW.

CLAIMS RE- MAINING AFTER AMENDMENT	HIGHEST NO. PREVIOUSLY PAID FOR	PRESENT EXTRA	SMALL ENTITY	OR	LARGE ENTITY	ADDITIONAL FEE
TOTAL: 11	MINUS: 20	0	X=\$		X=\$0	=\$0
INDEP: 2	MINUS: 3	0	X=\$		X=\$0	=\$0
					TOTAL ADDITION. FEE DUE:	=\$0

CERTIFICATE OF FAX TRANSMISSION:

I hereby certify that this correspondence with all indicated enclosures is being transmitted by telefax to (703) 872-9310 on the date indicated below, and is addressed to: Assistant Commissioner for Patents, Washington, D. C. 20231.

Walter F. Fasse 1/31/03  
Name: Walter F. Fasse - Date: January 31, 2003

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